# 1.5 A Low Dropout **Linear Regulator**

The NCP565 low dropout linear regulator will provide 1.5 A at a fixed output voltage or an adjustable voltage down to 0.9 V. The fast loop response and low dropout voltage make this regulator ideal for applications where low voltage and good load transient response are important. Device protection includes current limit, short circuit protection, and thermal shutdown. The NCP565 is packaged in a 5 pin D<sup>2</sup>PAK for adjustable voltage version and a 3 pin D<sup>2</sup>PAK for fixed voltage version.

# **Features**

- Pb-Free Packages are Available
- Ultra Fast Transient Response (< 1.0 μs)
- Low Ground Current (1.1 mA @ Iload = 1.5 A)
- Low Dropout Voltage (0.9 V @ Iload = 1.5 A)
- Low Noise (28 µVrms)
- 0.9 V Reference Voltage
- Adjustable Output Voltage from 7.7 V down to 0.9 V
- 1.2 V Fixed Output Version. Other Fixed Voltages Available on Request
- Current Limit Protection (3.5 A)
- Thermal Shutdown Protection (155°C)

# **Typical Applications**

- Servers
- ASIC Power Supplies
- Post Regulation for Power Supplies
- Constant Current Source



# ON Semiconductor®

http://onsemi.com

# **MARKING DIAGRAMS**



# D<sup>2</sup>PAK **CASE 936 FIXED**



Tab = Ground Pin 1.  $V_{in}$ 

2. Ground 3. V<sub>out</sub>



# D<sup>2</sup>PAK **CASE 936A ADJUSTABLE**



Tab = Ground Pin 1. N.C.

2. V<sub>in</sub>

3. Ground

4. Vout

5. Adj

xx = R4 or 12

= Assembly Location

WL = Wafer Lot

= Year

WW = Work Week

= Pb-Free

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

#### **PIN DESCRIPTION**

| Pin No.<br>Adjustable Version | Pin No.<br>Fixed Version | Symbol           | Description   |
|-------------------------------|--------------------------|------------------|---|
| 1                             | -                        | N.C.             | -   |
| 2                             | 1                        | V <sub>in</sub>  | Positive Power Supply Input Voltage   |
| 3, Tab                        | 2, Tab                   | Ground           | Power Supply Ground   |
| 4                             | 3                        | V <sub>out</sub> | Regulated Output Voltage  |
| 5                             | -                        | Adj              | This pin is to be connected to the $R_{\text{sense}}$ resistors on the output. The linear regulator will attempt to maintain 0.9 V between this pin and ground. Refer to Figure 1 for the equation. |

#### **MAXIMUM RATINGS**

| Rating  | Symbol           | Value                         | Unit |
|---|------------------|-------------------------------|------|
| Input Voltage (Note 1)  | V <sub>in</sub>  | 9.0                           | V    |
| Output Pin Voltage  | V <sub>out</sub> | -0.3 to V <sub>in</sub> + 0.3 | V    |
| Adjust Pin Voltage  | V <sub>adj</sub> | –0.3 to V <sub>in</sub> + 0.3 | V    |
| Thermal Characteristics (Note 2) Case 936A Thermal Resistance, Junction-to-Air Thermal Resistance, Junction-to-Case |                  | 45<br>5.0                     | °C/W |
| Operating Junction Temperature Range  | T <sub>J</sub>   | -40 to 150                    | °C   |
| Storage Temperature Range   |                  | -55 to 150                    | °C   |

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. This device series contains ESD protection and exceeds the following tests:

Human Body Model JESD 22-A114-B Machine Model JESD 22-A115-A

2. The maximum package power dissipation is:

$$P_D = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$

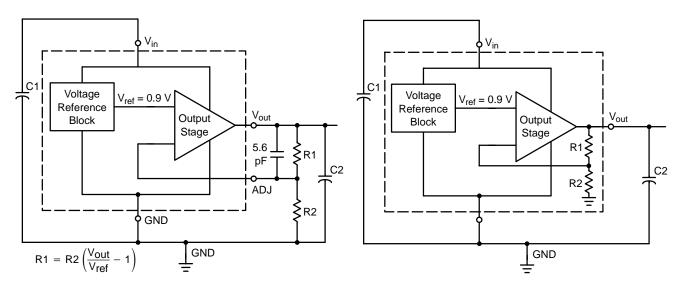


Figure 1. Typical Schematic, Adjustable Output

Figure 2. Typical Schematic, Fixed Output

**ELECTRICAL CHARACTERISTICS** ( $V_{in} - V_{out} = 1.6 \text{ V}$ ,  $V_{out} = 0.9 \text{ V}$ ,  $T_J = 25^{\circ}\text{C}$ ,  $C_{in} = C_{out} = 150 \text{ }\mu\text{F}$ , values unless otherwise noted.)

| Characteristic  | Symbol              | Min            | Тур  | Max            | Unit  |
|---|---------------------|----------------|------|----------------|-------|
| ADJUSTABLE OUTPUT VERSION   |                     |                |      | •              |       |
| Reference Voltage (10 mA < $I_{out}$ < 1.5 A; 2.5 V < $V_{in}$ < 9.0 V; $T_{J}$ = -10 to 105°C) | $V_{ref}$           | 0.882<br>(-2%) | 0.9  | 0.918<br>(+2%) | V     |
| Reference Voltage (10 mA < $I_{out}$ < 1.5 A; 2.5 V < $V_{in}$ < 9.0 V; $T_{J}$ = -40 to 125°C) | V <sub>out</sub>    | 0.873<br>(-3%) | 0.9  | 0.927<br>(+3%) | V     |
| ADJ Pin Current   | I <sub>Adj</sub>    | -              | 30   | -              | nA    |
| Line Regulation (I <sub>out</sub> = 10 mA)  | Reg <sub>line</sub> | _              | 0.03 | _              | %     |
| Load Regulation (10 mA < I <sub>out</sub> < 1.5 A)  | Reg <sub>load</sub> | _              | 0.03 | _              | %     |
| Dropout Voltage (I <sub>out</sub> = 1.5 A) (Note 3)   | Vdo                 | _              | 0.9  | 1.3            | V     |
| Current Limit   | I <sub>lim</sub>    | 1.6            | 3.5  | _              | Α     |
| Ripple Rejection (120 Hz; I <sub>out</sub> = 1.5 A)   | RR                  | -              | 85   | _              | dB    |
| Ripple Rejection (1 kHz; I <sub>out</sub> = 1.5 A)  | RR                  | -              | 75   | _              | dB    |
| Thermal Shutdown  |                     | -              | 150  | _              | °C    |
| Ground Current (I <sub>out</sub> = 1.5 A)   | Iq                  | -              | 1.1  | 3.0            | mA    |
| Output Noise Voltage (f = 100 Hz to 100 kHz, I <sub>out</sub> = 1.5 A)                          | V <sub>n</sub>      | -              | 28   | _              | μVrms |
| FIXED OUTPUT VOLTAGE  |                     |                |      |                |       |
| Output Voltage (10 mA < $I_{out}$ < 1.5 A; 2.5 V < $V_{in}$ < 9.0 V; $T_{J}$ = -10 to 105°C)    | V <sub>out</sub>    | 1.176<br>(-2%) | 1.2  | 1.224<br>(+2%) | %     |
| Output Voltage (10 mA < $I_{out}$ < 1.5 A; 2.5 V < $V_{in}$ < 9.0 V; $T_{J}$ = -40 to 125°C)    | V <sub>out</sub>    | 1.164<br>(-3%) | 1.2  | 1.236<br>(+3%) | %     |
| Line Regulation (I <sub>out</sub> = 10 mA)  | Reg <sub>line</sub> | _              | 0.03 | -              | %     |
| Load Regulation (10 mA < I <sub>out</sub> < 1.5 A)  | Reg <sub>load</sub> | -              | 0.03 | -              | %     |
| Dropout Voltage (I <sub>out</sub> = 1.5 A) (Note 3)   | Vdo                 | _              | 0.9  | 1.3            | V     |
| Current Limit   | I <sub>lim</sub>    | 1.6            | 3.5  | -              | Α     |
| Ripple Rejection (120 Hz; I <sub>out</sub> = 1.5 A)   | RR                  | _              | 85   | -              | dB    |
| Ripple Rejection (1 kHz; I <sub>out</sub> = 1.5 A)  | RR                  | _              | 75   | -              | dB    |
| Thermal Shutdown  |                     | _              | 150  | -              | °C    |
| Ground Current (I <sub>out</sub> = 1.5 A)   | Iq                  | -              | 1.1  | 3.0            | mA    |
| Output Noise Voltage (f = 100 Hz to 100 kHz, I <sub>out</sub> = 1.5 A)                          | V <sub>n</sub>      | -              | 28   | -              | μVrms |

<sup>3.</sup> Dropout voltage is a measurement of the minimum input/output differential at full load.

#### **ORDERING INFORMATION**

| Device         | Nominal Output Voltage* | Package                         | Shipping <sup>†</sup> |
|----------------|-------------------------|---------------------------------|-----------------------|
| NCP565D2T      | Adj                     | D <sup>2</sup> PAK              | 50 Tube               |
| NCP565D2TR4    | Adj                     | D <sup>2</sup> PAK              | 800 Tape & Reel       |
| NCP565D2TR4G   | Adj                     | D <sup>2</sup> PAK<br>(Pb-Free) | 800 Tape & Reel       |
| NCP565D2T12    | Fixed                   | D <sup>2</sup> PAK              | 50 Tube               |
| NCP565D2T12R4  | Fixed                   | D <sup>2</sup> PAK              | 800 Tape & Reel       |
| NCP565D2T12R4G | Fixed                   | D <sup>2</sup> PAK<br>(Pb-Free) | 800 Tape & Reel       |

<sup>\*</sup>For other fixed output versions, please contact the factory.
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### TYPICAL CHARACTERISTICS

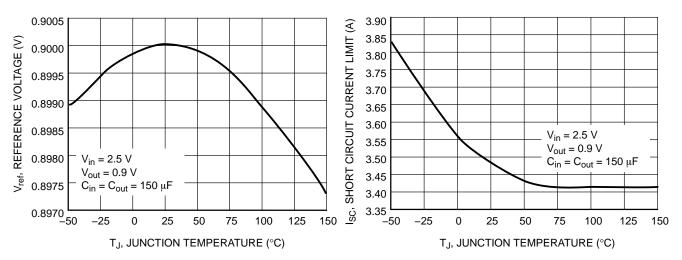


Figure 3. Output Voltage vs. Temperature

Figure 4. Short Circuit Current Limit vs. Temperature

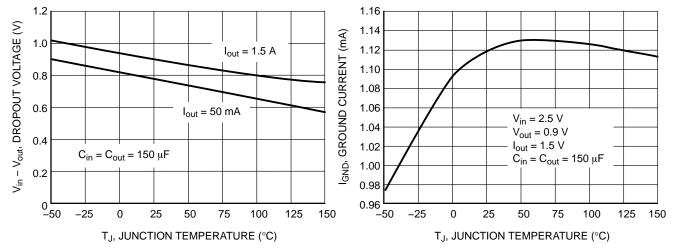


Figure 5. Dropout Voltage vs. Temperature

1.28 100 90 1.26 80 RIPPLE REJECTION (dB) 1.24 70 1.22 60 1.2 50 1.18 40 = 1.5 A 30 1.16 20 1.14 10 1.12 0 300 1200 1500 100000 1000000 0 600 900 10 100 1000 10000 Iout, OUTPUT CURRENT (mA) F, FREQUENCY (Hz)

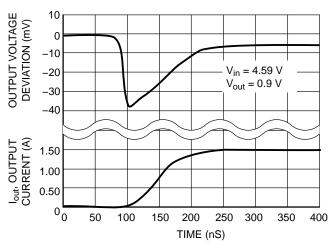
Figure 7. Ground Current vs. Output Current

Figure 8. Ripple Rejection vs. Frequency

Figure 6. Ground Current vs. Temperature

I<sub>GND</sub>, GROUND CURRENT (mA)

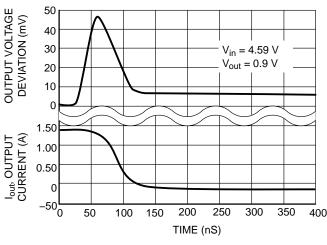
# TYPICAL CHARACTERISTICS



10 OUTPUT VOLTAGE DEVIATION (mV) -10  $V_{in} = 4.59 \text{ V}$ -20  $V_{out} = 0.9 \text{ V}$ -30 -40 l<sub>out</sub>, OUTPUT CURRENT (A) 1.50 1.00 0.50 00 0.5 1.0 1.5 2.0 2.5 3.0 3.5 4.0 TIME (µs)

Figure 9. Load Transient from 10 mA to 1.5 A

Figure 10. Load Transient from 10 mA to 1.5 A



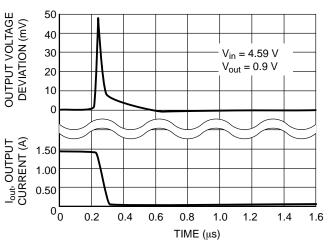
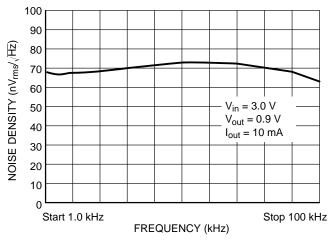


Figure 11. Load Transient from 1.5 A to 10 mA

Figure 12. Load Transient from 1.5 A to 10 mA



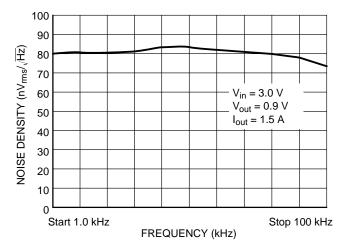


Figure 13. Noise Density vs. Frequency

Figure 14. Noise Density vs. Frequency

#### **APPLICATION INFORMATION**

The NCP565 low dropout linear regulator provides adjustable voltages at currents up to 1.5 A. It features ultra fast transient response and low dropout voltage. These devices contain output current limiting, short circuit protection and thermal shutdown protection.

# Input, Output Capacitor and Stability

An input bypass capacitor is recommended to improve transient response or if the regulator is located more than a few inches from the power source. This will reduce the circuit's sensitivity to the input line impedance at high frequencies and significantly enhance the output transient response. Different types and different sizes of input capacitors can be chosen dependent on the quality of power supply. A 150  $\mu F$  OSCON 16SA150M type from Sanyo should be adequate for most applications. The bypass capacitor should be mounted with shortest possible lead or track length directly across the regulator's input terminals.

The output capacitor is required for stability. The NCP565 remains stable with ceramic, tantalum, and aluminum–electrolytic capacitors with a minimum value of 1.0  $\mu F$  as long as the ESR remains between 50 m $\Omega$  and 2.5  $\Omega$ . The NCP565 is optimized for use with a 150  $\mu F$  OSCON 16SA150M type in parallel with a 10  $\mu F$  OSCON 10SL10M type from Sanyo. The 10  $\mu F$  capacitor is used for best AC stability while 150  $\mu F$  capacitor is used for achieving excellent output transient response. The output capacitors should be placed as close as possible to the output pin of the device. If not, the excellent load transient response of NCP565 will be degraded.

#### **Adjustable Operation**

The typical application circuit for the adjustable output regulators is shown in Figure 1. The adjustable device develops and maintains the nominal 0.9 V reference voltage between Adj and ground pins. A resistor divider network R1 and R2 causes a fixed current to flow to ground. This current creates a voltage across R1 that adds to the 0.9 V across R2 and sets the overall output voltage.

The output voltage is set according to the formula:

$$V_{out} = V_{ref} \times \left(\frac{R1 + R2}{R2}\right) - I_{Adj} \times R2$$

The adjust pin current, Iadj, is typically 30 nA and normally much lower than the current flowing through R1 and R2, thus it generates a small output voltage error that can usually be ignored.

# **Load Transient Measurement**

Large load current changes are always presented in microprocessor applications. Therefore good load transient performance is required for the power stage. NCP565 has the feature of ultra fast transient response. Its load transient responses in Figures 9 through 12 are tested on evaluation board shown in Figure 15. On the evaluation board, it consists of NCP565 regulator circuit with decoupling and filter capacitors and the pulse controlled current sink to obtain load current transitions. The load current transitions are measured by current probe. Because the signal from current probe has some time delay, it causes un–synchronization between the load current transition and output voltage response, which is shown in Figures 9 through 12.

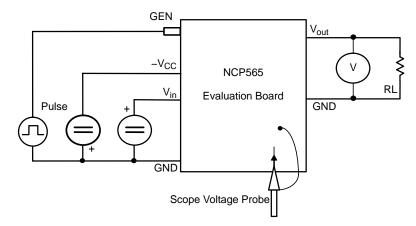


Figure 15. Schematic for Transient Response Measurement

# **PCB Layout Considerations**

Good PCB layout plays an important role in achieving good load transient performance. Because it is very sensitive to its PCB layout, particular care has to be taken when tackling Printed Circuit Board (PCB) layout. The figures below give an example of a layout where parasitic elements are minimized. For microprocessor applications it is customary to use an output capacitor network consisting of

several capacitors in parallel. This reduces the overall ESR and reduces the instantaneous output voltage drop under transient load conditions. The output capacitor network should be as close as possible to the load for the best results. The schematic of NCP565 typical application circuit, which this PCB layout is base on, is shown in Figure 16. The output voltage is set to 3.3 V for this demonstration board according to the feedback resistors in the Table 1.

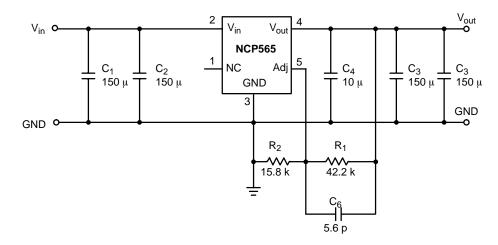


Figure 16. Schematic of NCP565 Typical Application Circuit

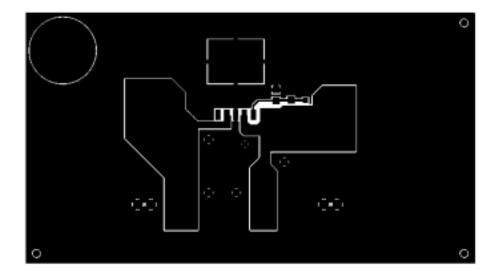


Figure 17. Top Layer

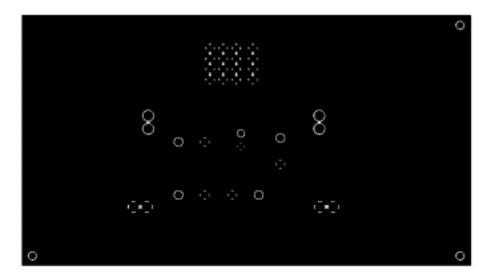


Figure 18. Bottom Layer

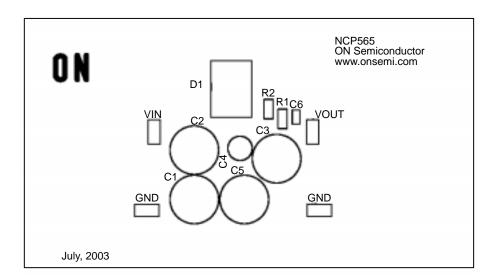


Figure 19. Silkscreen Layer

Table 1. Bill of Materials for NCP565 Adj Demonstration Board

| Item | Used # | Component                                     | Designators    | Suppliers        | Part Number    |
|------|--------|---|----------------|------------------|----------------|
| 1    | 4      | Radial Lead Aluminum Capacitor<br>150 μF/16 V | C1, C2, C3, C5 | Sanyo Oscon      | 16SA150M       |
| 2    | 1      | Radial Lead Aluminum Capacitor<br>10 μF/10 V  | C4             | Sanyo Oscon      | 10SL10M        |
| 3    | 1      | SMT Chip Resistor (0805) 15.8 K 1%            | R2             | Vishay           | CRCW08051582F  |
| 4    | 1      | SMT Chip Resistor (0805) 42.2 K 1%            | R1             | Vishay           | CRCW08054222F  |
| 5    | 1      | SMT Ceramic Capacitor (0603) 5.6 pF 10%       | C6             | Vishay           | VJ0603A5R6KXAA |
| 6    | 1      | NCP565 Low Dropout Linear Regulator           | U1             | ON Semiconductor | NCP565D2TR4    |

#### **Protection Diodes**

When large external capacitors are used with a linear regulator it is sometimes necessary to add protection diodes. If the input voltage of the regulator gets shorted, the output capacitor will discharge into the output of the regulator. The discharge current depends on the value of the capacitor, the output voltage and the rate at which  $V_{\rm in}$  drops. In the NCP565 linear regulator, the discharge path is through a large junction and protection diodes are not usually needed. If the regulator is used with large values of output capacitance and the input voltage is instantaneously shorted to ground, damage can occur. In this case, a diode connected as shown in Figure 20 is recommended.

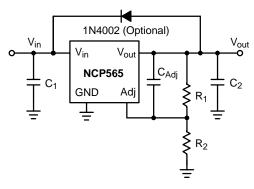


Figure 20. Protection Diode for Large Output Capacitors

#### **Thermal Considerations**

This series contains an internal thermal limiting circuit that is designed to protect the regulator in the event that the maximum junction temperature is exceeded. This feature provides protection from a catastrophic device failure due to accidental overheating. It is not intended to be used as a substitute for proper heat sinking. The maximum device power dissipation can be calculated by:

$$P_D = \frac{T_J(max) - T_A}{R_{\theta JA}}$$

The devices are available in surface mount  $D^2PAK$  package. The package has an exposed metal tab that is specifically designed to reduce the junction to air thermal resistance,  $R_{\theta JA}$ , by utilizing the printed circuit board copper as a heat dissipater. Figure 21 shows typical  $R_{\theta JA}$  values that can be obtained from a square pattern using economical single sided 2.0 ounce copper board material. The final product thermal limits should be tested and quantified in order to insure acceptable performance and reliability. The actual  $R_{\theta JA}$  can vary considerably from the graph shown. This will be due to any changes made in the copper aspect ratio of the final layout, adjacent heat sources, and air flow.

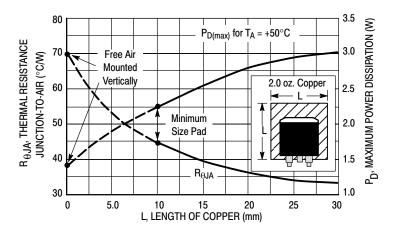
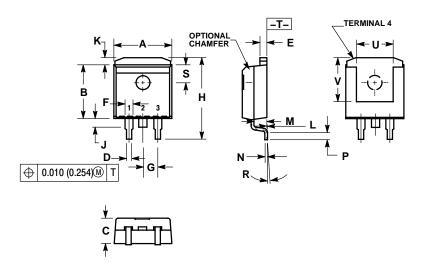


Figure 21. 3-Pin and 5-Pin D<sup>2</sup>PAK
Thermal Resistance and Maximum Power
Dissipation vs. P.C.B Length

# **PACKAGE DIMENSIONS**

# D<sup>2</sup>PAK-3 **D2T SUFFIX** CASE 936-03 **ISSUE B**



- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: INCH.

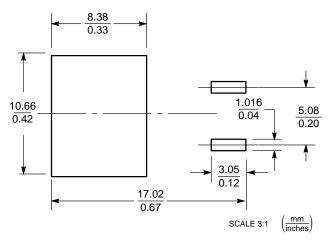
  3. TAB CONTOUR OPTIONAL WITHIN DIMENSIONS A AND K.

  4. DIMENSIONS U AND V ESTABLISH A MINIMUM MOUNTING SURFACE FOR TERMINAL 4.

  5. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.025 (0.635) MAXIMUM.

|     | INCHES    |       | MILLIMETERS |        |
|-----|-----------|-------|-------------|--------|
| DIM | MIN       | MAX   | MIN         | MAX    |
| Α   | 0.386     | 0.403 | 9.804       | 10.236 |
| В   | 0.356     | 0.368 | 9.042       | 9.347  |
| С   | 0.170     | 0.180 | 4.318       | 4.572  |
| D   | 0.026     | 0.036 | 0.660       | 0.914  |
| Е   | 0.045     | 0.055 | 1.143       | 1.397  |
| F   | 0.051     | REF   | 1.295 REF   |        |
| G   | 0.100 BSC |       | 2.540 BSC   |        |
| Н   | 0.539     | 0.579 | 13.691      | 14.707 |
| J   | 0.125 MAX |       | 3.175 MAX   |        |
| K   | 0.050     | REF   | 1.270 REF   |        |
| L   | 0.000     | 0.010 | 0.000       | 0.254  |
| M   | 0.088     | 0.102 | 2.235       | 2.591  |
| N   | 0.018     | 0.026 | 0.457       | 0.660  |
| Р   | 0.058     | 0.078 | 1.473       | 1.981  |
| R   | 5° REF    |       | 5° REF      |        |
| S   | 0.116 REF |       | 2.946 REF   |        |
| U   | 0.200 MIN |       | 5.080 MIN   |        |
| ٧   | 0.250 MIN |       | 6.350 MIN   |        |

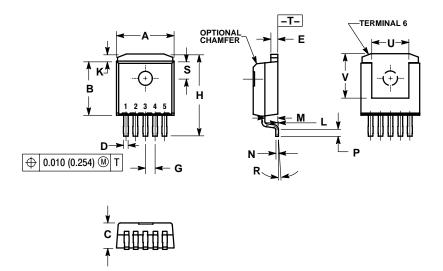
# **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# **PACKAGE DIMENSIONS**

# D<sup>2</sup>PAK-5 **D2T SUFFIX** CASE 936A-02 **ISSUE B**



#### NOTES:

- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: INCH.

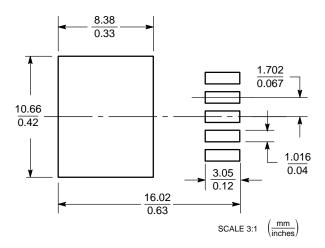
  3. TAB CONTOUR OPTIONAL WITHIN DIMENSIONS A AND K.

  4. DIMENSIONS U AND V ESTABLISH A MINIMUM MOUNTING SURFACE FOR TERMINAL 6.

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|     | INCHES    |       | MILLIMETERS |        |
|-----|-----------|-------|-------------|--------|
| DIM | MIN       | MAX   | MIN         | MAX    |
| Α   | 0.386     | 0.403 | 9.804       | 10.236 |
| В   | 0.356     | 0.368 | 9.042       | 9.347  |
| C   | 0.170     | 0.180 | 4.318       | 4.572  |
| D   | 0.026     | 0.036 | 0.660       | 0.914  |
| Е   | 0.045     | 0.055 | 1.143       | 1.397  |
| G   | 0.067 BSC |       | 1.702 BSC   |        |
| H   | 0.539     | 0.579 | 13.691      | 14.707 |
| K   | 0.050     | REF   | 1.270 REF   |        |
| L   | 0.000     | 0.010 | 0.000       | 0.254  |
| M   | 0.088     | 0.102 | 2.235       | 2.591  |
| N   | 0.018     | 0.026 | 0.457       | 0.660  |
| P   | 0.058     | 0.078 | 1.473       | 1.981  |
| R   | 5° REF    |       | 5° REF      |        |
| S   | 0.116 REF |       | 2.946 REF   |        |
| 5   | 0.200 MIN |       | 5.080 MIN   |        |
| ٧   | 0.250 MIN |       | 6.350 MIN   |        |

# **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

The product described herein (NCP565), may be covered by one or more of the following U.S. patents: 5,920,184; 5,834,926. There may be other patents pending.

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